### 501848839 03/12/2012

# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Emory Michael Budzinski	02/15/2012

### **RECEIVING PARTY DATA**

Name:	Weather Shield Mfg., Inc.	
Street Address:	One Weather Shield Plaza	
City:	Medford	
State/Country:	WISCONSIN	
Postal Code:	54451	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	6722089

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	232116-314602
NAME OF SUBMITTER:	Douglas H. Siegel

**Total Attachments: 1** source=314602#page1.tif

PATENT REEL: 027840 FRAME: 0788 3H \$40 00 67220

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#### **ASSIGNMENT**

WHEREAS, Emory Michael Budzinski residing at 5301 Thornapple Road, Wausau, WI 54401 (hereinafter referred to as Assignor), has invented certain new and useful improvements in CONCEALED STRUCTURAL MULLION for which a United States Letters Patent was issued on April 20, 2004, as Patent No. 6,722,089.

WHEREAS, Weather Shield Mfg., Inc. a corporation of the state of Wisconsin, having a place of business at One Weather Shield Plaza, Medford, Wisconsin 54451 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable considerations, Assignor hereby sells, assigns and transfers unto said Assignee the full and exclusive right, title and interest to the said invention in the United States and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and in any and all foreign countries and in and to any and all divisions, reissues, continuations, continuation-in-part, and extensions thereof including the full right to claim for any such applications the benefits of the International Convention.

Assignor hereby authorizes and requests the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Assignee as the owner of the entire right, title and interest in and to the same, for the sole use and behoof of said Assignee, its successors and assigns.

FURTHER, Assignor agrees to communicate to said Assignee or its representatives any facts known to Assignor respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part, substitution, renewal, and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Assignee, make all rightful oaths and generally do everything possible to aid said Assignee, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand on the date appearing next to my signature.

Inventor:

Date:

10344874.1

RECORDED: 03/12/2012

**PATENT**